APPLICA	BLE STAN	IDARD										
OPERATING		25.2 52 25.2 (1255.4)		NOTE 1)	STORAGE) TEMPERATURE RANGE		<u>.</u> [-10°C TO + 60°C (NOTE3)				
RATING	TEMPERATURE RANGE OPERATING		· · · · · · · · · · · · · · · · · · ·	STO		RAGE		-				
RATING	HUMIDITY RA	NGE			HUMIDITY RANGE APPLICABLE			40 % TO 70 % (NOT		1		
	VOLTAGE		AC/DC 100V			CONNECTOR			DF50#-30DS-1C			
CURRENT			AWG 28 : 1.0		APPLICAB CONTACT		. C		DF50-2830SCFA			
			AWG 30 : 0.9 A AWG 32 : 0.7 A			DF50-3032SC				ГА		
			SPEC		ΔΤΙζ	SINC						
17	 ГЕМ		TEST METHOD	JII 10/	<u> </u>			DEOI	JIREMENTS	Тат	AT	
	RUCTION	1	TEST WETHOD				<u>'</u>	\LQC	JIKLIVILIVIO	Q1	1 🗥	
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.				ΤX	ΤX		
MARKING		CONFIRMED VISUALLY.			1				X	X		
	IC CHARA										•	
CONTACT F	RESISTANCE	AC 20mV	MAX 1mA (DC OR 1000	Hz).		30mΩ N	IAX.			X	_	
INSULATIOI RESISTANO	INSULATION		100V DC.			500MΩ MIN.				X	<u> </u>	
VOLTAGE F		300V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.				X	1 –		
MECHAN	NICAL CH	ARACTE	ERISTICS							ı		
INSERTION	FORCE		TESTING BY APPLICABLE CONNECTOR				INSERTION FORCE: 50.0 N MAX.					
WITHDRAW					WITHDRAWAL FORCE: 4.0 N MIN.				X			
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_		
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE			① NO ELECTRICAL DISCONTINUITY OF 1μs.				-	+		
							DAMAG		RACK OR LOOSENESS	X	-	
SHOCK		DIRECTIONS. 490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			OF	PARTS.						
			ACTERISTICS									
DAMP HEA				% 96 h		ന വേ	NTACT F	RESIS	STANCE: 50mΩ MAX.		T	
(STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			② INSULATION RESISTANCE: 100MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				_			
RAPID CHANGE OF		TEMPERATURE -55→+85°C			① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.							
TEMPERATURE		TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.							X	_		
COUN	T D	ESCRIPTION IN COMMENT	ON OF REVISIONS		DESIG	 SNED			CHECKED		ATE	
				<u> </u>			APPRO	VED	KI. AKIYAMA	11	11, 11, 24	
					APPROVED CHECKED							
							DESIG		OM. MIYAMOTO	+ -	11. 22	
								TT. OHSAKO TT. OHSAKO		11. 21		
Note OT Qualification Test AT Assurance Test V Applicable Test				DRAWN DAWING NO.		ELC4-32000	11.11.21					
Note QT:Qualification Test AT:Assurance Test X:Applicable Te			501	PART	RAWING NO.			DF50-30DP-1V (52				
HS.			CATION SHEET LECTRIC CO., LTD.	00.170					, , , , , , , , , , , , , , , , , , ,		1/2	
FORM URBOALL O. 1			OL LLLOTRIC CO., LTD.		CODE NO.		0000 0001 0-02 2			Δ	1/2	

TEST METHOD SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	REQUIREMENTS SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	QT	АТ
	100 70 ST THE GOTT FIGURE BEING HAIMEROED.	×	_
1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 220°C WITHIN 60 sec «PREHEATING AREA» 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_
	MIN 220°C WITHIN 60 sec 《PREHEATING AREA》 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s.	MIN 220°C WITHIN 60 sec 《PREHEATING AREA》 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s.	MIN 220°C WITHIN 60 sec 《PREHEATING AREA》 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s.

REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 1: INCLUDING THE TEMPERATURE RISE BY SOMETH.

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD.

AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specifid, refer to JIS C 5402.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-320002-02			
HS				DF50-30DP-1V (52)			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL665	-0001-8-52	Δ	2/2	